

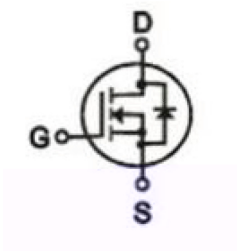
/ Descriptions

x

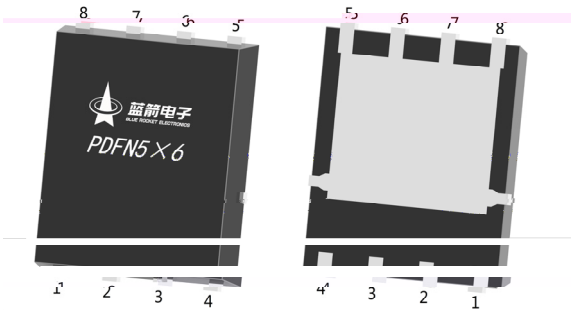
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



Pin	极性
1	S
2	S
3	S
4	G
5	D
6	D
7	D
8	D

/ Marking

/ Electrical Characteristics(Ta=25)

		Ω Ω				

/ Electrical Characteristic Curve

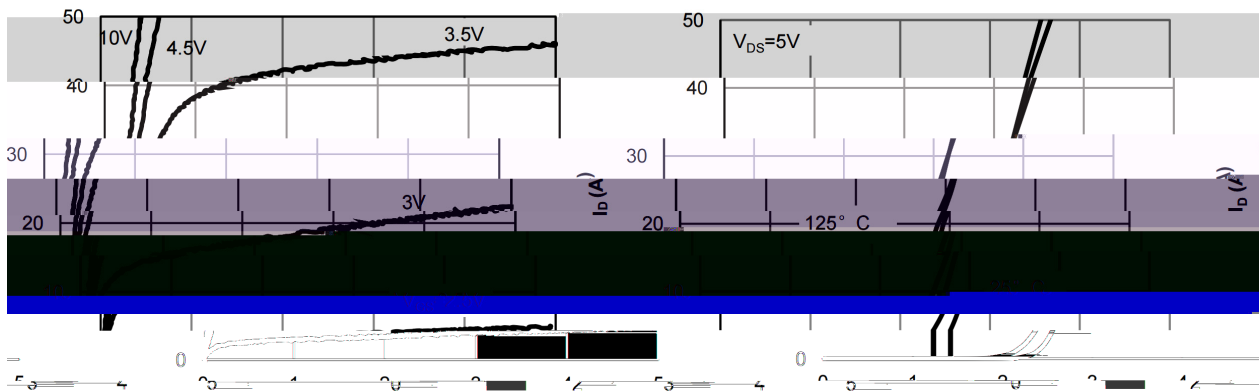
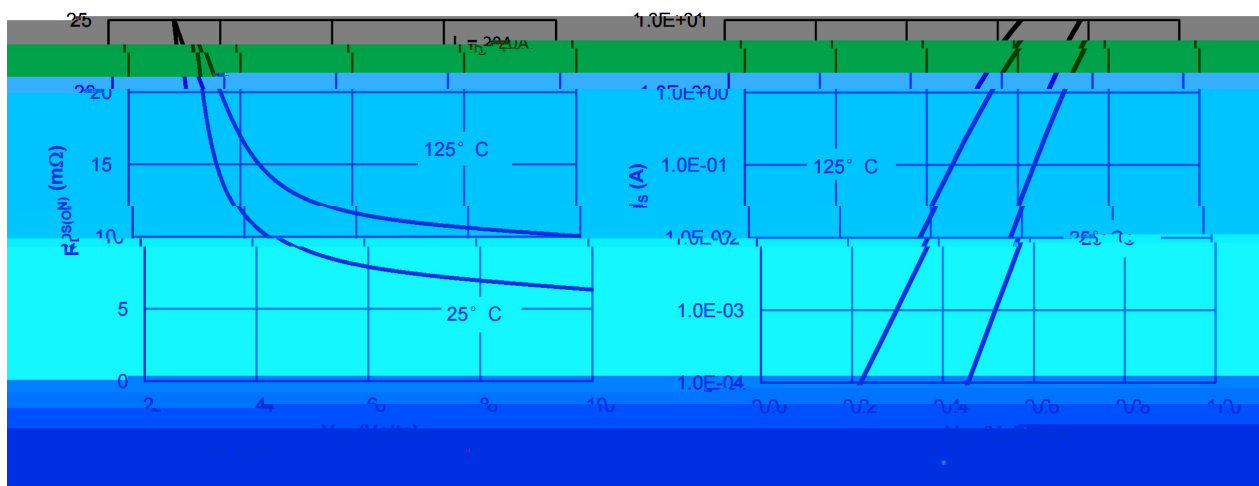
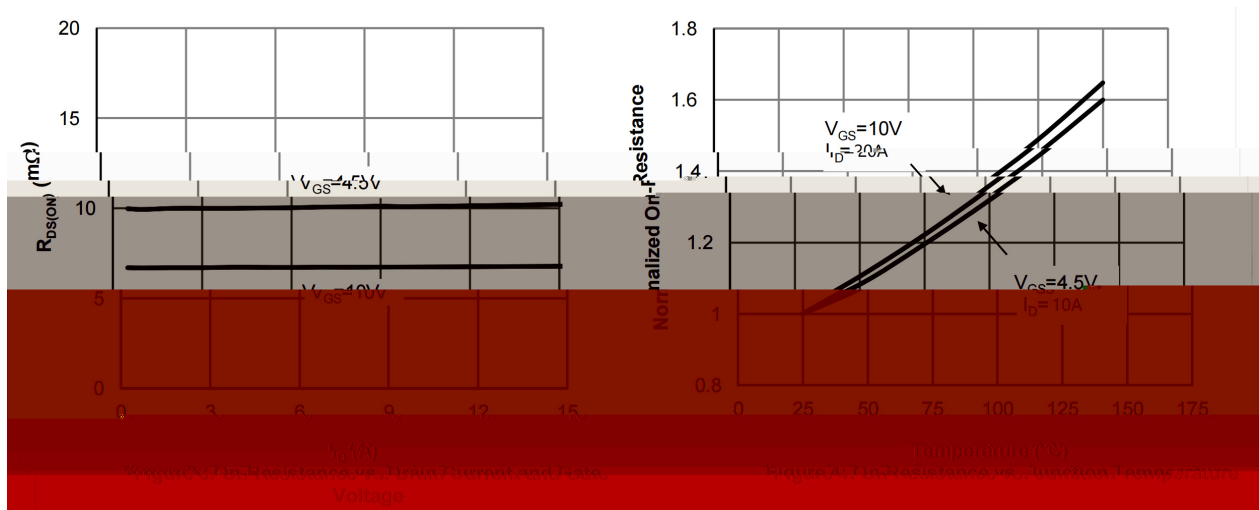
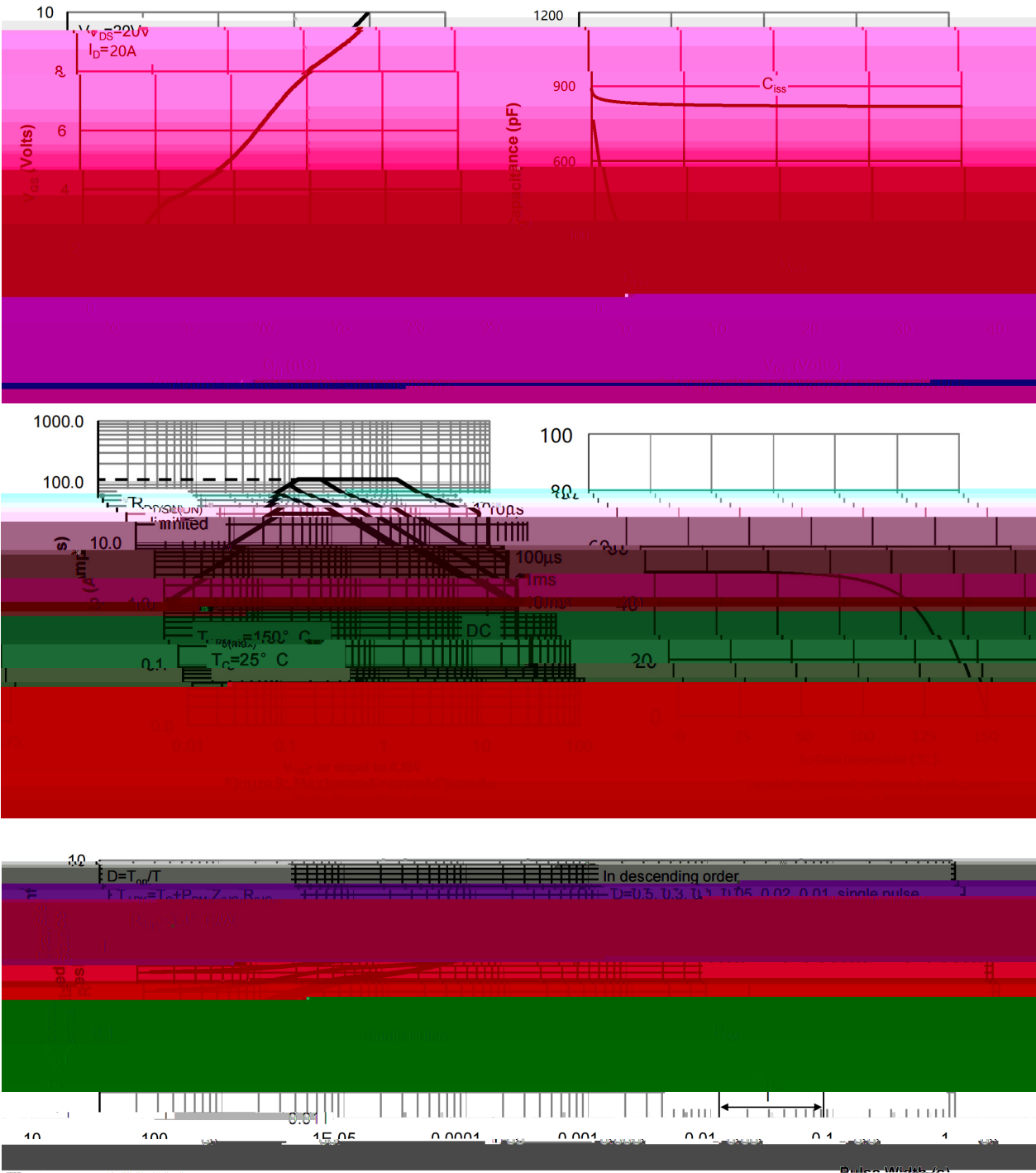
ts)
Characteristics

Figure 1: On-Region Characteristics

Figure 2: Transfer



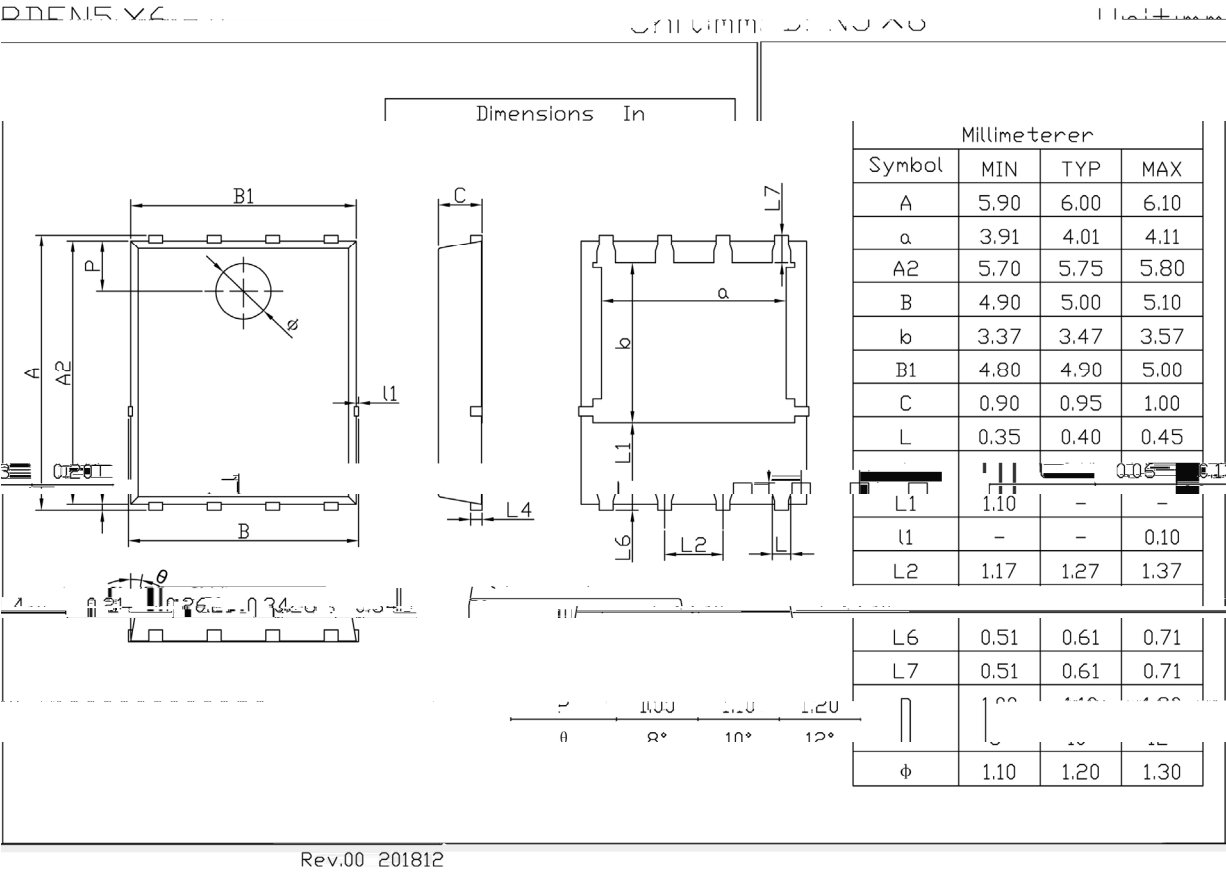
/ Electrical Characteristic Curve



Normalized Maximum Transient Thermal Impedance

Figure 11: Norm

I Package Dimensions



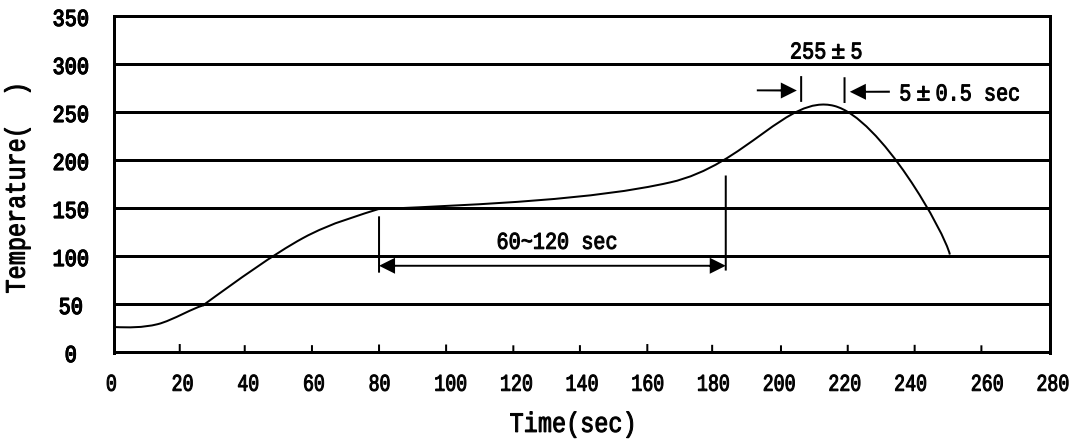
/ Marking Instructions



BR

Q

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
×						×	×	×

/ Notices